



TW

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Ta-Ko Chuang, et al.)	Examiner: AFTERGUT, JEFF H
)	
Serial No.:	10/798,235)	Art Unit: 1733
)	
Filed:	March 10, 2004)	Our Ref: B-4442 CIP 621763-9
)	
For:	"METHOD FOR BONDING AN)	Date: April 4, 2007
	INTEGRATED CIRCUIT DEVICE TO A)	
	GLASS SUBSTRATE")	Re: Amendment and Response
)	

AMENDMENT AND RESPONSE

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir,

This is in reply to the Office Action mailed on January 8, 2007, a response to which is due no later than April 8, 2007.

Please amend the above-identified application as described below and consider the following remarks. **All amendments and remarks herein are made without prejudice.**

Amendments to the Claims are reflected in the listing of claims that begins on page 3 of this paper. A **specification amendment** appears on page 2 hereof.

Remarks/Arguments begin on page 7 of this paper.